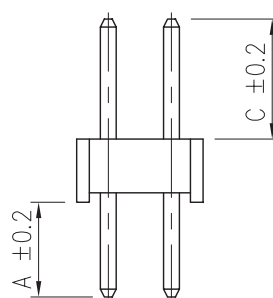
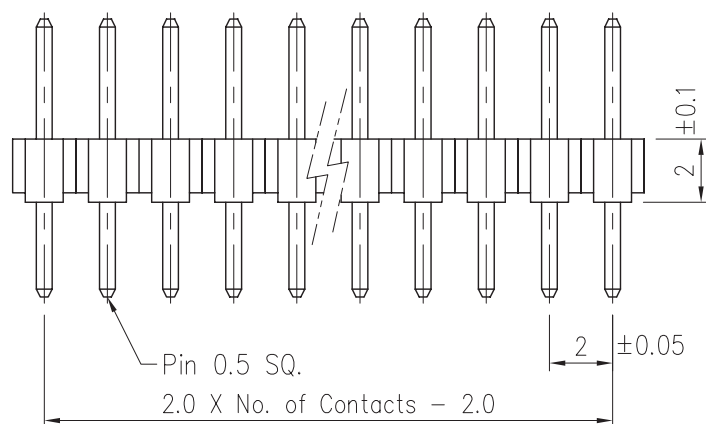
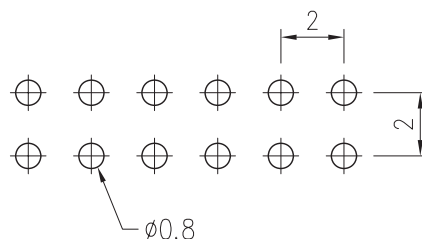


Recommended
P.C. Board Hole Layout



Specifications

Current Rating: 2 Amp
Insulator Resistance: 1000 Megohms min.
Contact Resistance: 20 m ohms max.
Dielectric Withstanding: AC 500V
Operating Temperature : -40°C ~ +105°C
Insulator Material: Polyester, UL 94V-0, P.B.T.
Contact Material: Brass
Contact Plating: See Options / Standard: Full Gold

Part Numbering System

SD200-H2.0 - XX - A-C - X

Series

No. of Pins

Terminal Dimensions Required

A = ... , C = ...

Contact Plating

Example: SD200-H2.0-12-4.00-5.00-G
with 12pins, A= 4.00, C = 5.00

* Contact Plating Option	Full Gold Plating	Gold Plated On Contact Area Tin Plated on Solder Area	Full Tin Plating
	G : Gold Flash G10: Gold 10u" G15: Gold 15u" G30: Gold 30u"	S: Gold Flash S10: Gold 10u" S15: Gold 15u" S30: Gold 30u"	T: Tin 100u"

General Tolerance	
X. ± 0.50	X.° ± 5°
.X ± 0.20	.X° ± 2°
.XX ± 0.10	.XX° ± 1°
Units : mm	

Rev. No. :